Search Notes			

Application No.	Applicant(s)	
10/603,976	JUNG ET AL.	
Examiner	Art Unit	
Stephen W. Smoot	2813	

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SEARCHED				
Class	Subclass	Date	Examiner	
438	637	7/19/2004	sws	
438	675	7/19/2004	sws	
438	684	7/19/2004	sws	SULL.
438	692	7/19/2004	sws	8,600
438	693	7/19/2004	sws	
252	79.1	7/19/2004	sws	
252	79.2	7/19/2004	sws	
Updated	Above	12/22/2004	sws	Soul
51	307	12/22/2004	sws) 8, W.L. ! W.L.
Updated	Above	5/13/2005	sws	W.
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INTERFERENCE SEARCHED				
Class	Subclass	Date	Examiner	
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SEARCH NOTES (INCLUDING SEARCH STRATEGY)		
	DATE	EXMR
Key Words: CMP - Chemical Mechanical Polishing, Perchloric Acid, Chloric Acid, Hypochlorous Acid,	7/19/2004	SNL sws
Bromic Acid, Perbromic Acid, Iodic Acid, Periodic Acid, Hard Pad;	7/19/2004	I.J.J.
Wordline - Polysilicon, Nitride Mask, Spacer, Contact Hole, Interlayer - BPSG, FSG, USG, PSG, TEOS.	7/19/2004	Solver Swist
Updated Above Search	12/22/2004	& .W.S
Updated Above Search - Plus Searched pH and Abrasives	5/13/2005	SW.S.
Search Tools - EAST (attached): USPAT; US PG PUBS; Derwent; EPO; JPO; IBM TDB	7/19/2004; 12-22-04; 8 5-13-05	sws